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Agilent Technologies

**EMPro 2012
October 2012
Examples**

Examples

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Examples

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Antenna

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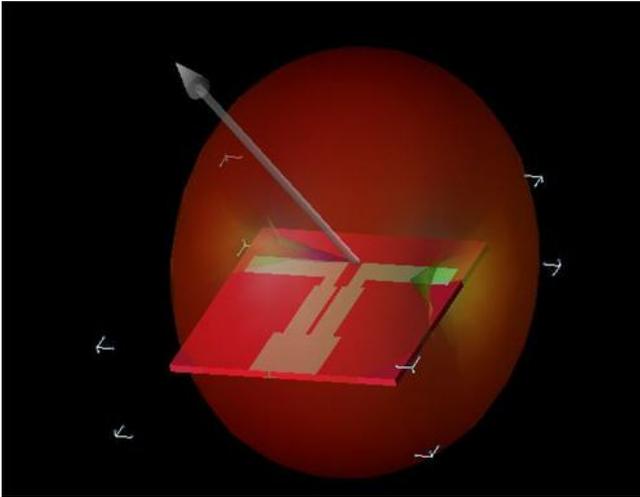
- *Microstrip Dipole Antenna* (example)
- *Microstrip Patch Antenna* (example)
- *Patch Antenna with TNC Connector* (example)

Microstrip Dipole Antenna

Location: In EMPro, choose **Help > Examples > Microstrip Dipole Antenna** to open the project.

Objective

This example describes the design of a Microstrip Dipole Antenna using both FDTD and FEM simulations in EMPro. The Microstrip Dipole Antenna is designed by Orban Microwave Products, Leuven, Belgium. This antenna in planar microstrip configuration is designed on FR4 substrate of thickness 1.6 mm. The dipole antenna is fed through a via from 50ohm microstrip line. The geometry modeling tools of EMPro are used to model two dimensional planar dipole and three dimensional via structure. The far field sensor is used to get far field radiation pattern in 2D and 3D. The antenna geometry is shown in the following figure:



Setup

FDTD:

The Broadband Gaussian Waveform is used to activate the source to achieve a broadband response for the antenna. The base cell size of 1mm is used to mesh the structure. It does not generate sufficient mesh along the Z direction, where the thickness of the substrate exists. To achieve accuracy, at least 3 cells should exist along the thickness of the substrate. To accommodate this, an adaptive mesh of 0.4mm is used in the Z direction within the thickness of the substrate. In addition, for all the objects of the geometry, automatic fixed points is used for gridding properties. This ensures that the meshes are falling on the edges of the objects. The generated mesh provides results up to 30GHz in a single simulation.

FEM:

For FEM simulation same geometry, port and boundary setup as of FDTD is used. FEM padding of 60 mm is used in all the directions.

Use the following archive file:

Archive file: **microstrip_dipole.zep**

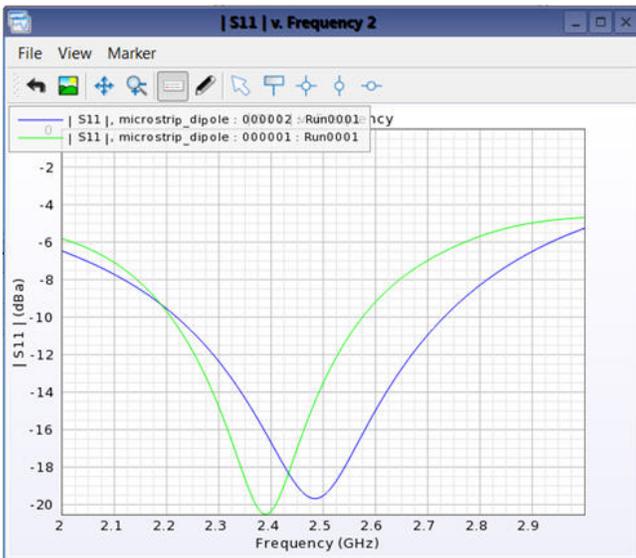
Analysis

The return loss (S11) for the antenna is shown in the following figure:

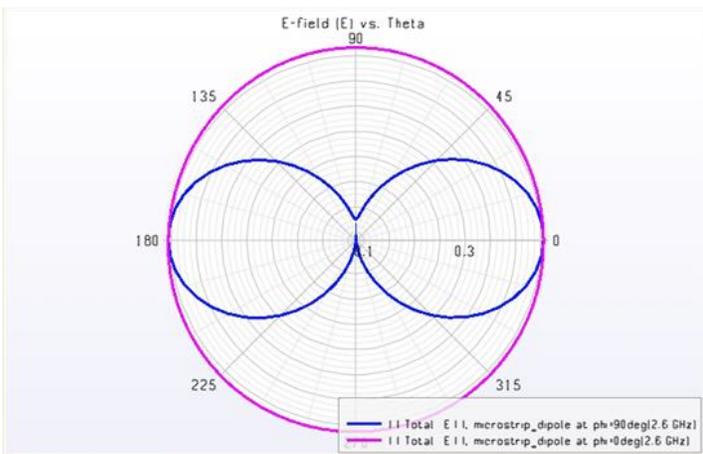
Examples



Comparison of S parameter between FDTD and FEM is shown in following figure:



The radiation pattern of Microstrip Dipole Antenna in Phi at 0 degree and Phi at 90 degree cut planes in polar plot for 2.6 GHz from FDTD simulation is shown in the following figure. The pattern is omni-directional (doublet) and is circular in phi at degree plane. In phi at 90 degree, the pattern lobes are not circular. They are flattened and the radiation intensity is greater than 0dB. The patterns from FEM are similar to FDTD.

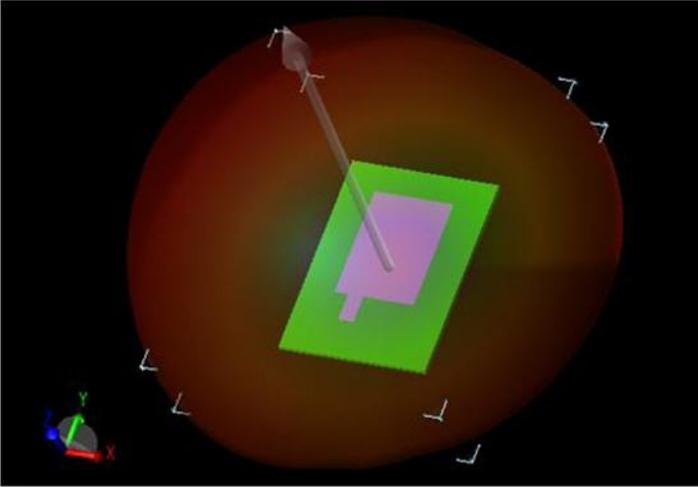


Microstrip Patch Antenna

Location: In EMPro, choose **Help > Examples > Microstrip Patch Antenna** to open the project.

Objective

This examples illustrates the design of Microstrip patch antenna using both FDTD and FEM simulations. This example is based on the paper "Applications of the Three Dimensional Finite Difference Time Domain Method to the Analysis of Planar Microstrip Circuits " by Sheen et al in the July 1990 issue of IEEE Transactions on Microwave Theory and Techniques. In this issue of MTT, you can refer to page numbers from 849 to 856 for more information. In this example, the Surface sensor that is located at port 1 is used to evaluate E,H,B field quantities along with Surface current J_c and poynting vector S . The far field sensor is used to get far field radiation pattern in 2D cut planes and 3D. The geometry of the microstrip patch antenna is shown in the following figure:



Setup

FDTD:

A Gaussian pulse is used as the source waveform for wideband frequency response. The base cell size of 0.3 mm is used for mesh in x and y directions. The base cell size 0.1mm is used along the thickness of the substrate. In addition, for all the objects of the geometry automatic fixed points is used in gridding properties. This ensures that meshes are falling on the edges of the objects. The absorbing boundary condition is used in all the sides with finite ground plane on the back of the substrate.

FEM:

For FEM simulation same geometry, port and boundary setup as of FDTD is used. FEM padding of 20 mm is used in all the directions.

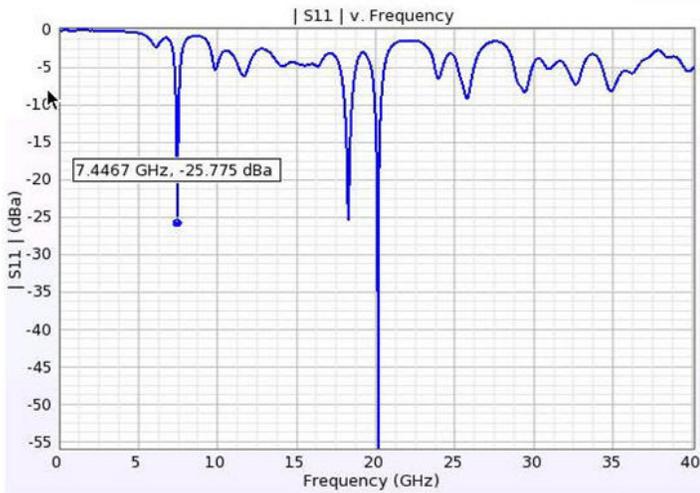
Use the following archive files:

Archive file: **Microstrip_patch_par.zep**

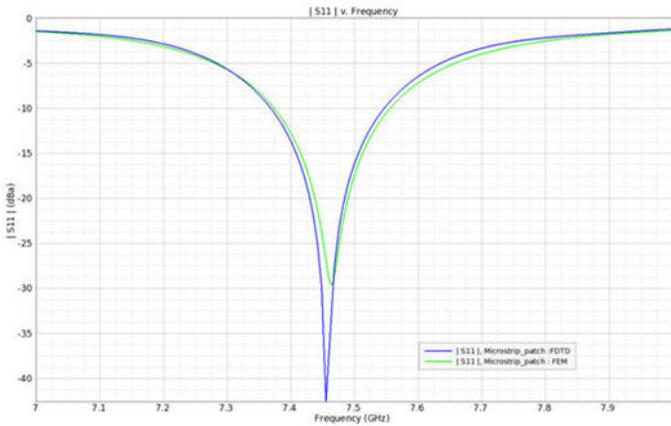
Analysis

Microstrip_patch.ep is the initial patch with fixed input stub length. The Gaussian waveform is used with the steady state data collected at 7.23GHz, 17.68GHz, 19.45GHz, 24.7GHz and 28.61GHz. The S parameter results over the band and at discreet frequency points are calculated. The S parameter plot over the frequency band is shown in the following figure:

Examples



Comparing S Parameter Plot for FDTD and FEM



There is close matching between S parameter result obtained from FEM and FDTD. These results also match closely with paper reported results.

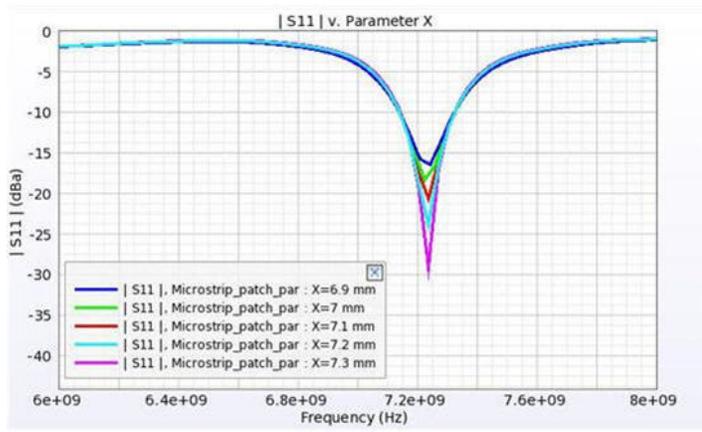
The radiation plots between FDTD and FEM are close. The Gain figure at discrete frequency points are also very close. For example at 7.47 GHz (where S parameter are almost same from both FEM and FDTD) the Gain from FDTD is 7.99 dBi & from FEM is 8 dBi.

In addition, the E, H, B fields as well as the surface current J with time steps are visible from the Near field sensor for FDTD. For FEM E and H plots can be seen from Advanced Visualization.

In `Microstrip_patch_par.ep`, the input stub length is specified as a parameter(X). The value of this parameter is varied from 6.9 mm to 7.3 mm in the steps 0.1 mm to vary the length of the stub.

The following figure displays the result of varying length on the S parameter.

Examples



Note: Simulate the project `Microstrip_patch_par.ep` to see the results. For more information about how to create a Microstrip patch antenna design, see *Microstrip Patch Antenna* (fdd).

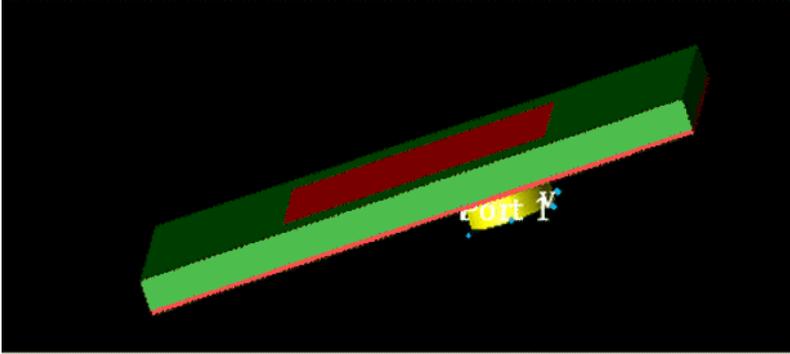
Patch Antenna with TNC Connector

Location: In EMPro, choose **Help > Examples > Patch Antenna with TNC**

Objective

This example illustrates the application of EMPro in designing a microstrip patch antenna with a TNC connector using FEM simulator. The TNC connector feeds the antenna from back-side of the antenna. The design band is C band. The patch antenna is designed on a substrate of 2.47 dielectric constant having thickness of 3.2 mm. The far field sensor is used to get far field radiation pattern in 2D cut planes and 3D.

The geometry of the microstrip patch antenna with TNC connector is shown in the following figure:



Setup

FEM:

FEM padding of 20 mm in upper Z, 0 mm in lower z and 30 mm in x and y directions are used. Absorbing boundary condition is used in all the directions. Waveguide port is used at the input of TNC connector.

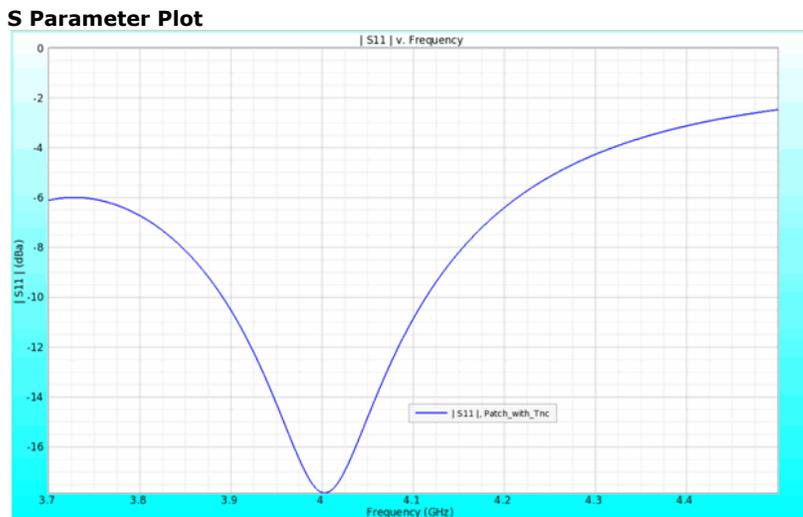
Use the following archive files:

Archive files: **Patch_with_TNC.zep**

Analysis

The frequency sweep is used from 3.7 GHz to 4.5 GHz. The FEM mesh refinement is carried out at the highest frequency of range.

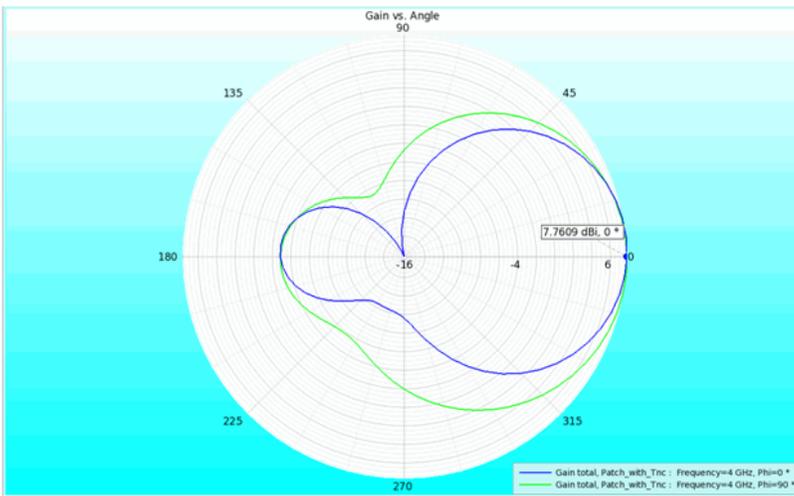
The S parameter plot over the frequency band is shown in the following figure:



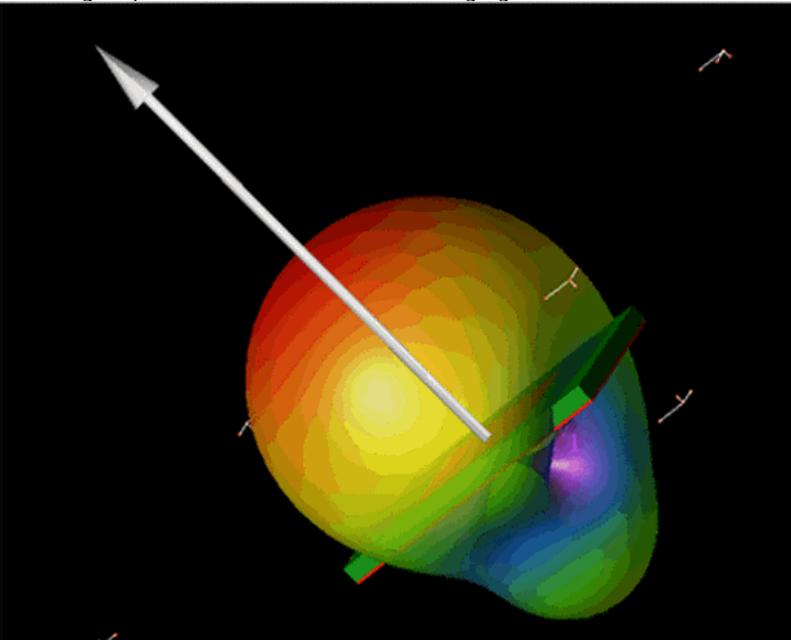
The resonance frequency of the antenna is 4 GHz.

The 2D gain pattern in $\Phi=0$ deg and 90 deg cut plane is shown below:

Examples



The 3D gain pattern is also shown in following figure:



Note
In **FEM Simulation > Frequency Plans > Field Storage > User Defined Frequency** is used. So the field data and radiation data is available at 3.7,4 and 4.5 GHz. If field and radiation data is required at any other frequency,then re-simulate the project using reuse option in FEM simulation.

Waveguide and Component

This section provides information about the following topics:

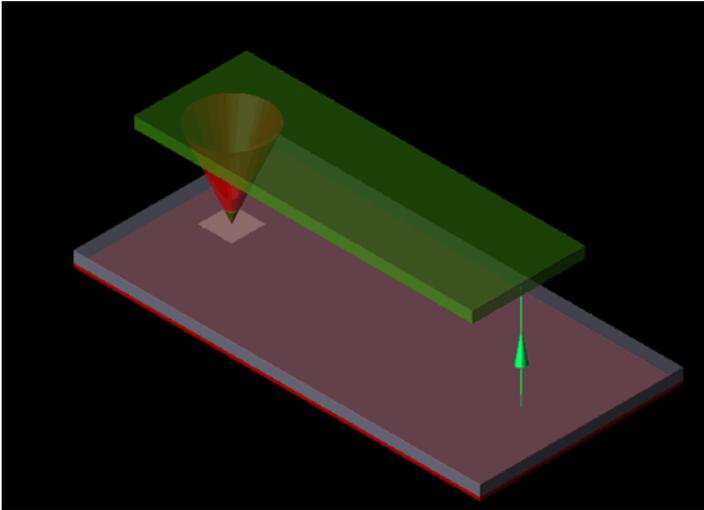
- *Scanning Microwave Microscopy Experiment* (example)
- *Magic Tee* (example)
- *Waveguide Power Divider* (example)
- *Waveguide to Coaxial Line Transition* (example)
- *Coaxial Waveguide Low Pass Filter* (example)

Scanning Microwave Microscopy Experiment

Location: In EMPro, choose **Help** > **Examples** > **Scanning Microwave Microscopy Experiment** to open the project.

Objective

This example shows how EMPro is used for simulating an SMM (Scanning Microwave Microscopy) experiment. SMM is a nanoscopic microscopy method, which is useful for measuring material properties at the nano scale. This method applies microwave signals to a sharp tip, which is in contact with the sample surface. Depending on the local material characteristic of the sample, a certain impedance is formed. This impedance is in a parallel circuit with some stray capacitance, formed by the test fixture. The current return path is provided by the capacitance formed by the sample holder. This return capacitance is usually not considered, so it is not modeled in this example project.



In the real world setup, the total impedance is indirectly measured by a network analyzer in reflection mode. Typically, the frequencies range from 1 GHz to 20 GHz.

Setup

With this EMPro example project, impedance values for different sample and probe geometries can be evaluated. The whole geometry is parameterized, so changes could be made very quickly. A description of the parameters is provided at the "Parameters" – menu of the example project. The parameters are grouped. Parameters with indices higher than zero (ie 1, 2, ...), are related to the various geometric objects. An index of -1 is used for internal calculation results and an index of zero is used for user modifiable parameters. Parameters that can be modified include geometric dimensions like sample size, x,y,z-coordinates of the contact point and tip radius.

Examples

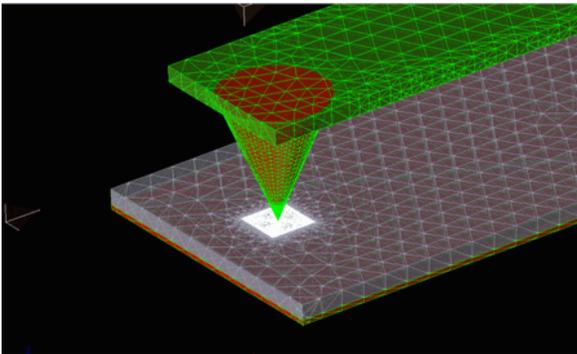
Name	Formula	Value	Description
f(x) Stackheight	Hmetal + Hsilicone + Hoxide	1.305e-05 m	-1: internal result, total stack height
f(x) Lcantilever	300 um	0.0003 m	0: user input, Length of cantilever beam
f(x) Rtip	100 nm	1e-07 m	0: user input, Tip radius
f(x) Hcantilever	80 um	8e-05 m	0: user input, distance between cantilever beam and contact plane
f(x) Hpad	1 um	1e-06 m	0: user input, height contact pad
f(x) Hoxide	50 nm	5e-08 m	0: user input, height of SiO2 layer
f(x) Hsilicone	10 um	1e-05 m	0: user input, height of silicone layer
f(x) Wsample	180 um	0.00018 m	0: user input, overall sample width
f(x) Lsample	360 um	0.00036 m	0: user input, overall sample length
f(x) Xsample	0	0	0: user input, sample x position
f(x) Ysample	130 um	0.00013 m	0: user input, sample y position
f(x) Wcantilever	100 um	0.0001 m	0: user input, width of cantilever beam
f(x) Xcontact	0	0	0: user input, x position of contact point
f(x) Ycontact	0	0	0: user input, y position of contact point
f(x) Zcontact	Stackheight - 1 nm	1.3049e-05 m	0: user input, z position of contact point
f(x) maxFreq	10 GHz	1e+10 Hz	0:Maximum frequency of interest for the project.
f(x) minFreq	10 GHz	1e+10 Hz	0:Minimum frequency of interest for the project.
f(x) Rsphere	Rtip	1e-07 m	1: object 1, Tip Radius = Radius of sphere

Fig- Parameter Window; Green Box: User Input

Analysis

Scanning Microwave Microscopy setup has been simulated with FEM solver. The duration of one simulation at a typical desktop computer (Dual Core, 2.6 GHz, 4GB Ram) is about 5 minutes with the provided settings. Making the SiO2 layer larger increases the number of tetrahedrons very quickly and therefore also the simulation time.

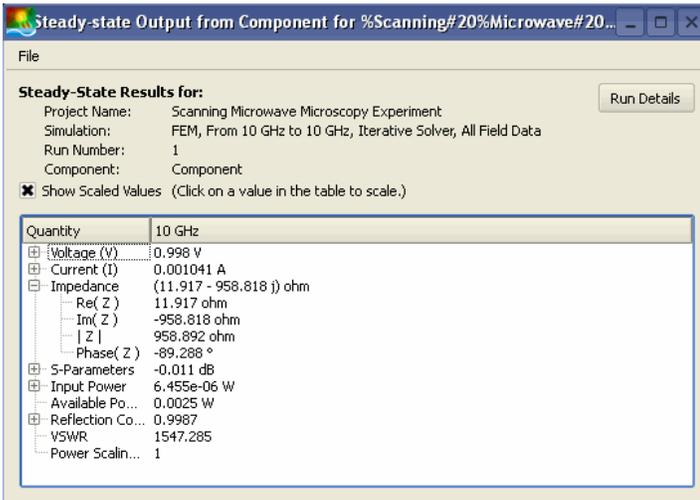
The following figure displays the FEM Mesh of Scanning Microwave Microscopy Design



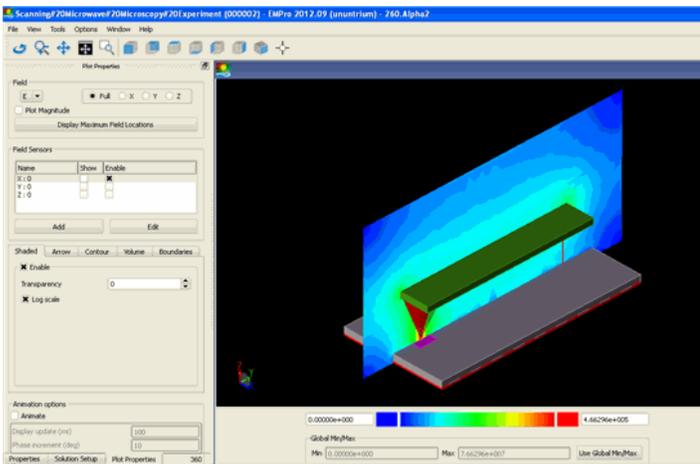
FEM Mesh of Scanning Microwave Microscopy Design is shown in the following figure. The meshing settings can be potentially optimized in particular the construction of the "Cone" as three parts with different meshing settings. The parameterization of the divided "cone" and corresponding tip-radius can be adapted to the specific experimental needs.

FEM simulated data at 10 GHz for input impedance is given below

Examples

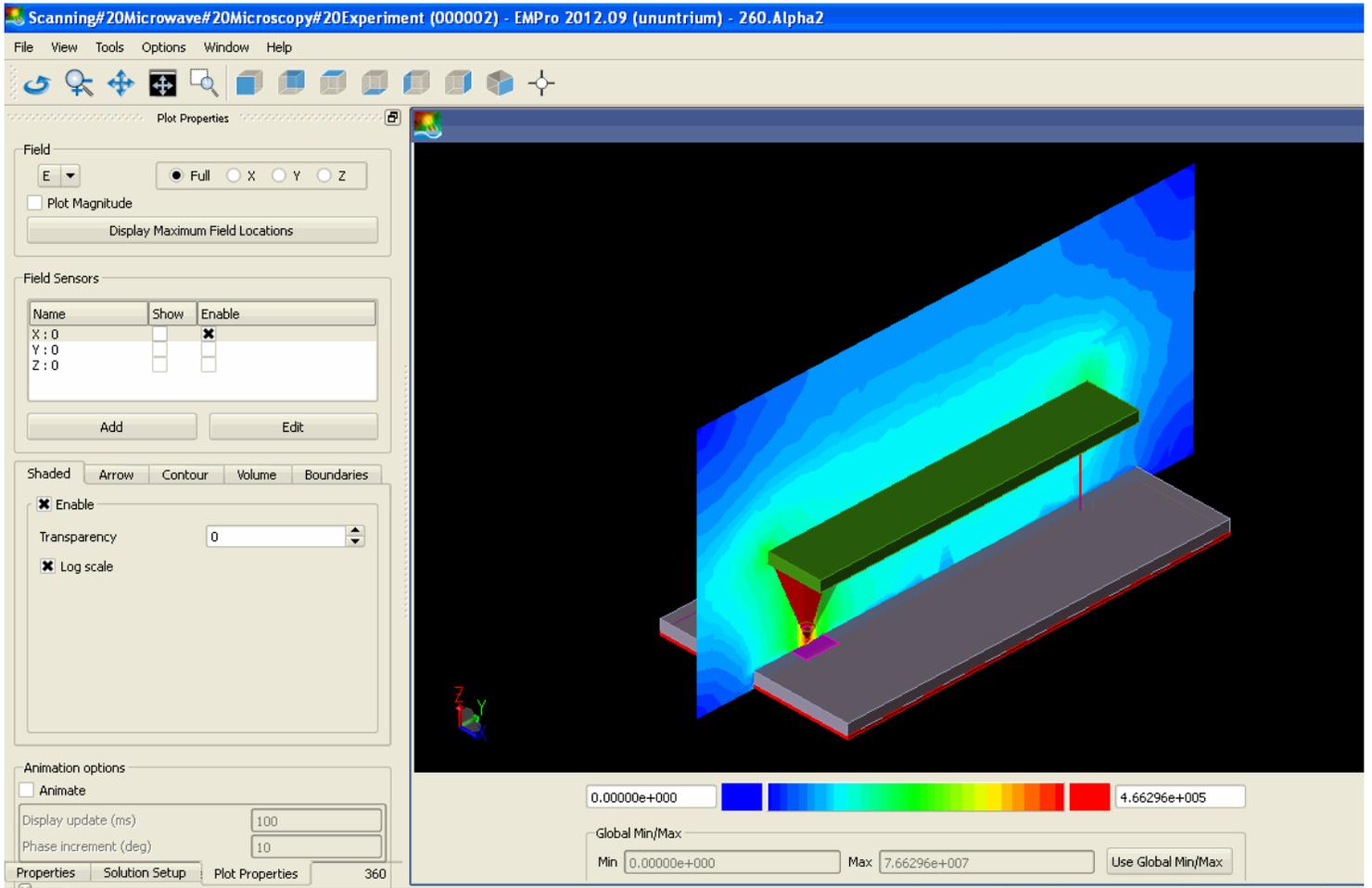


The following figure displays the numerical results at 10GHz and shows the contour plot of E-field on Microscopic scanner tips and Field under Cantilever



[Click here to enlarge this image \(example\)](#)

Examples



Coaxial Waveguide Low Pass Filter

Location: In EMPro, choose **Help** > **Examples** > **Coaxial Waveguide Low Pass Filter** to open the project.

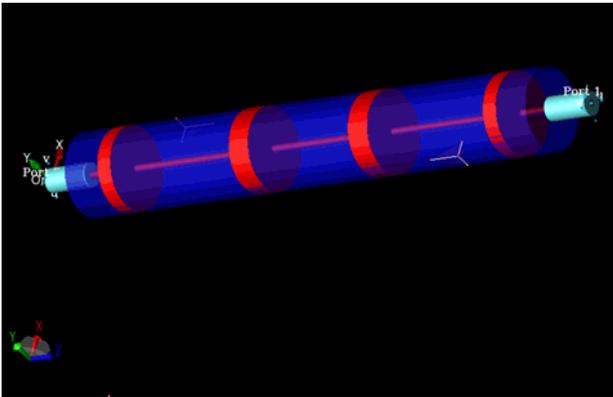
Objective

This example illustrates the design of Low pass filter using periodic Hi-Low impedance topology, realized by disc on rod structure with coaxial waveguide arrangement. Coaxial waveguide ports has been used as a input and output port of the structure. Later parametric study has been done to remove the existing spike in the pass band and improve the overall return loss. FEM Simulation has been used for analysis. This 'Coaxial waveguide Low pass filter can be used for various GSM band applications, where we can use it to filter out higher order modes and improve the overall rejection at the stop band.

It consists of tee or pi sections with series inductance and shunt capacitance. The cutoff frequency determined by the product of inductance and capacitance in each sections. For series inductor, a section of coaxial line with a higher characteristic impedance than that of normal line is used. For shunt capacitance, a length of line (discs) with a lower than normal characteristics impedance is used.

This example has three stages:

- Stage 1: Design a Low pass filter for specific cutoff frequency. In this design, four disc are used, last two discs are mirror image of first two, to make structure symmetric. Disc has been covered with Teflon sheet to support the disc on rod structure and maintain the isolation with outer cylindrical cavity.
- Stage 2: Illustrate the effect of disc width on cutoff frequency. By increasing the disc width, cutoff frequency has been shifted towards lower side of frequency band.
- Stage 3: To achieve flat response over the band, discs relative location and width has been parameterized. By variation in disc relative location and disc width, flat pass band response and improved return loss is achieved.



Setup

Archive file: Coaxial waveguide LPF .zep

The following section lists the parameters used to achieve optimized filter response.

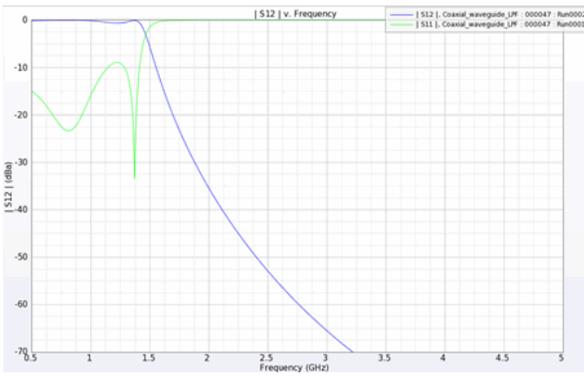
Stage 1

Filter response with spike in pass band:

- **W_in_initial** : This is disc 1 and 2 width values equal to 2.2 mm.
- **W_out_initial**: This is disc 3 and 4 width values equal to 1.6 mm.
- **Old_loc_in**: This is initial location of disc 1 and 2.
- **Old_loc_out**: This is initial location of disc 3 and 4.

S- parameter response:

Examples

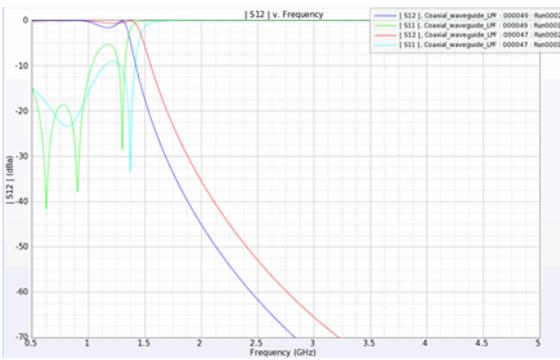


Stage 2

To illustrate the effect of variation in disc width on shifting of cutoff frequency

- **W_{in_final}** : 3 mm
- **W_{out_final}**: 2 mm

S- parameter Response:

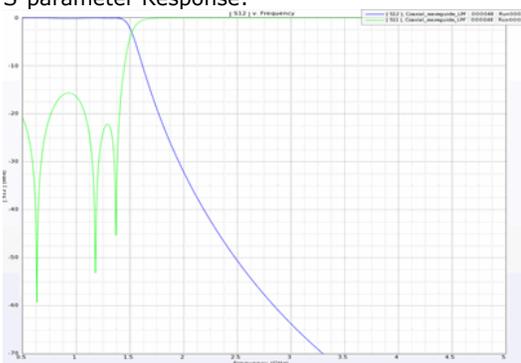


Stage 3

To achieve flat pass band response over the band and improved overall return loss in pass band.

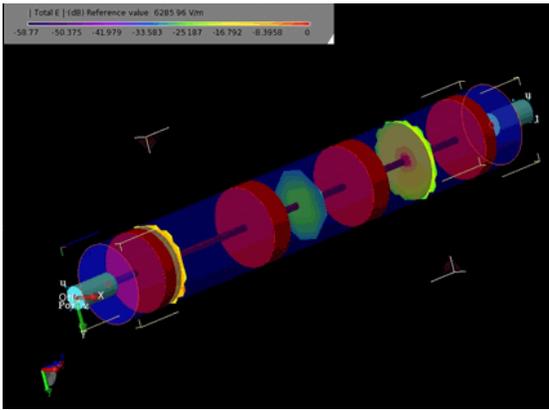
- **W_{in_final}**: This is the optimized disc width of 1 and 2= 1.8 mm.
- **W_{outfinal}**: This is optimized width of disc 3 and 4= 1.2 mm.
- **Loc_{in_variation}**: This the optimized location of disc 1 and 2= 1.3 mm.
- **Loc_{out_variation}**: This the optimized final location of disc 1 and 2= 0.5 mm.

S-parameter Response:



Electric filed propagation along the different discs inside the structure

Examples

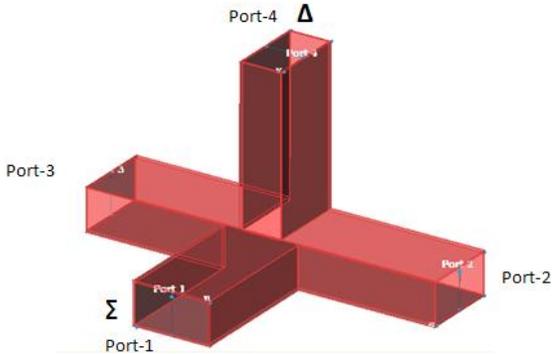


Magic Tee

Location: In EMPro, choose **Help > Examples > Magic Tee** to open the project.

Objective

This example shows the application of waveguide ports in EMPro. A magic tee is a four-port, 180 degree hybrid splitter, realized in waveguide. Like all of the coupler and splitter structures, the magic tee can be used as a power combiner, or a divider. It is ideally lossless, so that all power into one port can be assumed to exit the remaining ports. Port 1 is the (sum) port, and is called the H-plane port. A signal incident on port 1 equally splits between ports 2 and 3, and the resulting signals are in phase. Ports 2 and 3 are called the co-linear ports, because they are the only two that are in line with each other. Port 4 is the (difference or delta) port, and is called the E-plane port. A signal incident on the difference port splits equally between ports 2 and 3, but the resulting signals are 180 degrees out of phase.



This example also helps to visualize how the E-field of a signal entering the sum port remains in the same up-and-down direction and polarity as it splits to ports 2 and 3, while the E-field of a signal entering the delta port wraps around in two opposing polarities as it splits between ports 2 and 3. The interior dimensions of the waveguide are 4 inch by 2 inch.

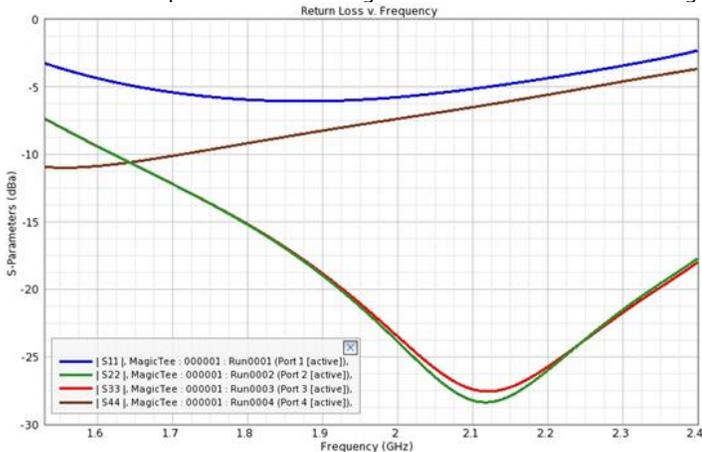
Setup

Magic Tee has been simulated with four waveguide ports each having one mode. Hollow waveguide has been modeled using shell operation. Waveguide walls are 0.1 inch thick metallic wall and it is filled with air. Simulation frequency range in from 1.4 GHz to 2.4 GHz.

Archive file: **MagicTee.zep**

Analysis

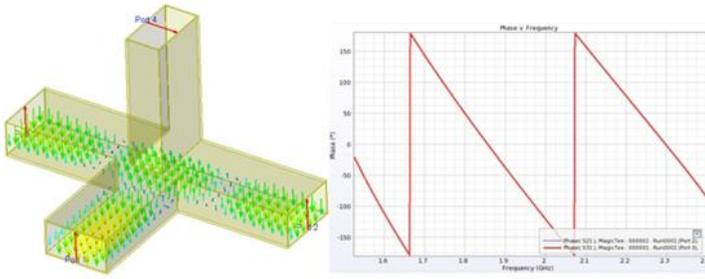
The return loss performance of Magic Tee is shown in the following figure:



E Field and Phase Plot of Sum and Delta Ports

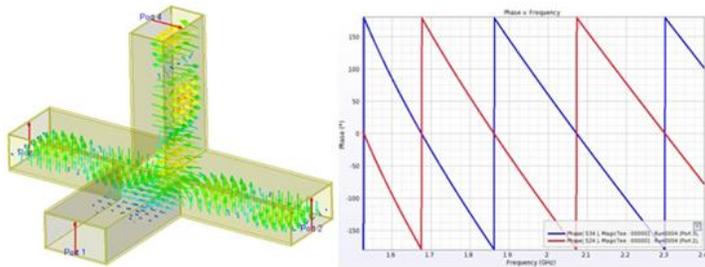
The following figure displays the E-field vectors for signals entering the sum port and diving in two collinear ports:

Examples



In this figure, the sum port excites in same phases in the collinear arms.

The following figure displays the E-field vectors for signals entering the delta port and diving in two collinear ports:



In this figure, the delta port excites in opposite phases in the collinear arms.

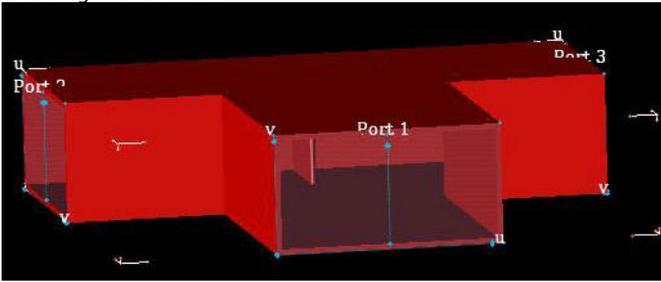
Note
Simulate the project MagicTee.ep to see the field plots in Advanced visualization results.

Waveguide Power Divider

Location: In EMPro, choose **Help** > **Examples** > **Waveguide Power Divider**

Objective

This example describes the design of waveguide power divider with waveguide ports using FEM engine of EMPro.



Setup

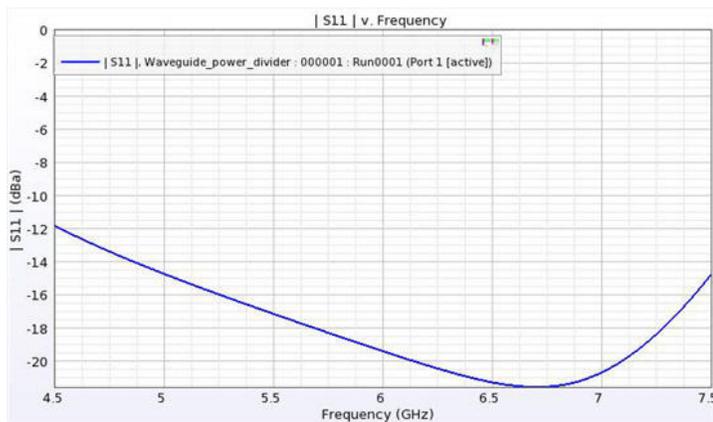
The waveguide used in power divider is WR159. This is equal power divider with input arm power divided into two output arm each having equal -3dB power. The design band is C band and a matching section is used to get return loss(S11) better than -10 dB between 4.5 GHz and 7.5 GHz.

Archive files: **Waveguide_power_divider.zep**

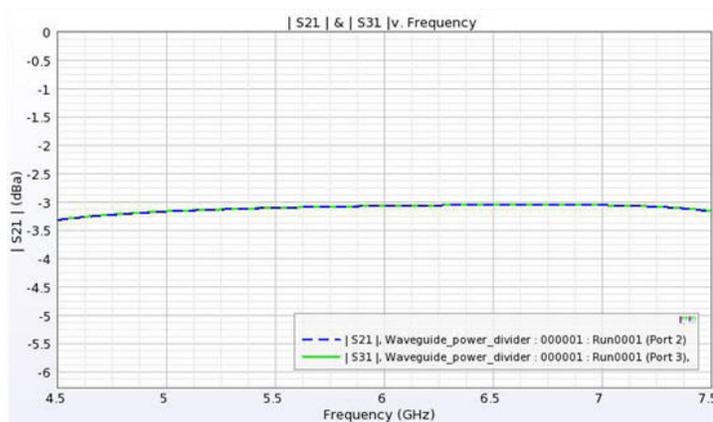
Analysis

The waveguide power divider is analyzed for dominant mode(TE01) propagation. The S parameter plot over the frequency band is shown in the following figure:

S11 Parameter Plot

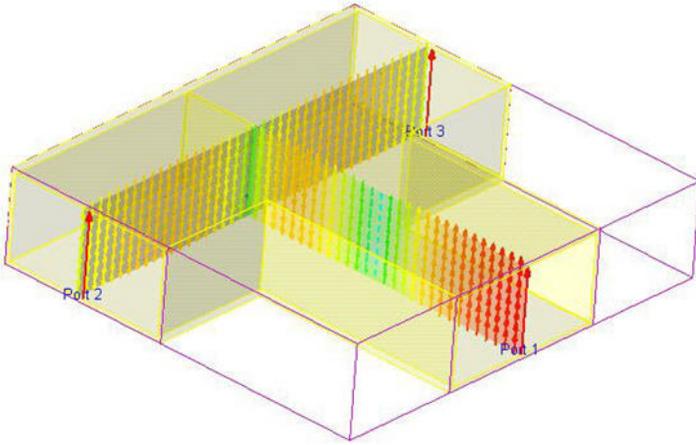


S21 & S31 Parameter Plot



The field plot can be seen from Advanced visualization. Field plot for one cut plane in input and output section is shown below:

Examples



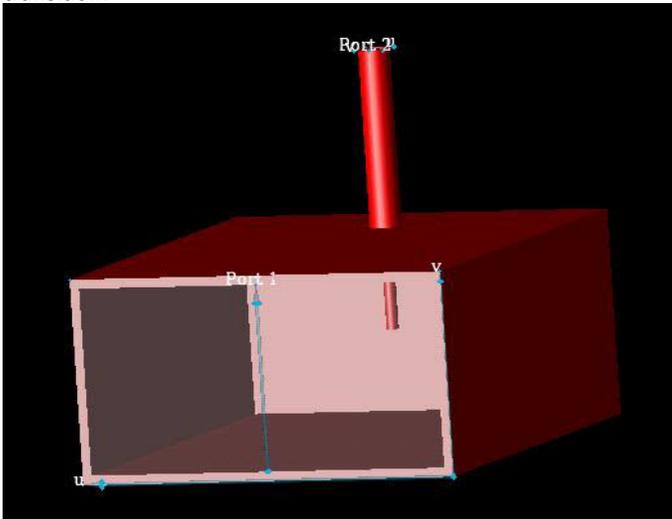
Note: Simulate the project **Waveguide_power_divider.ep** to see the field plots in Advanced visualization results.

Waveguide to Coaxial Transition

Location: In EMPro, choose **Help** > **Examples** > **Waveguide to Coax.**

Objective

This example describes the design of waveguide to coaxial line transition with waveguide ports using FEM engine of EMPro. The following figure displays a Waveguide to Coaxial line transition:



Setup

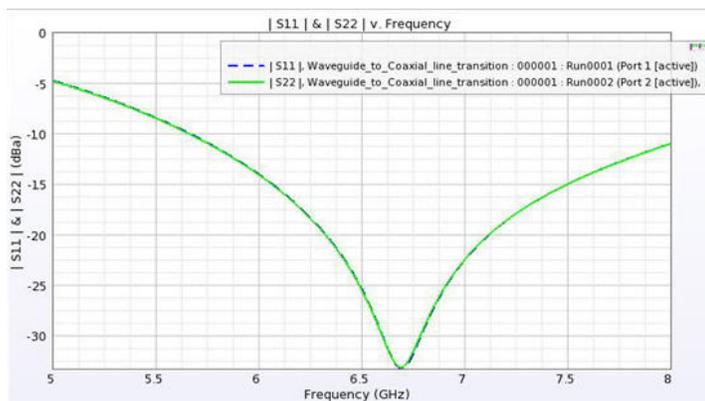
The waveguide used in transition design is WR159. The coaxial section is of 50 Ohm with air dielectric. The design band is C band and probe depth in waveguide section and short plane location is used to get return loss(S11 & S22) better than -10dB between 5 GHz and 8 GHz.

Archive files: **Waveguide_to_Coaxial_line_transition.zep**

Analysis

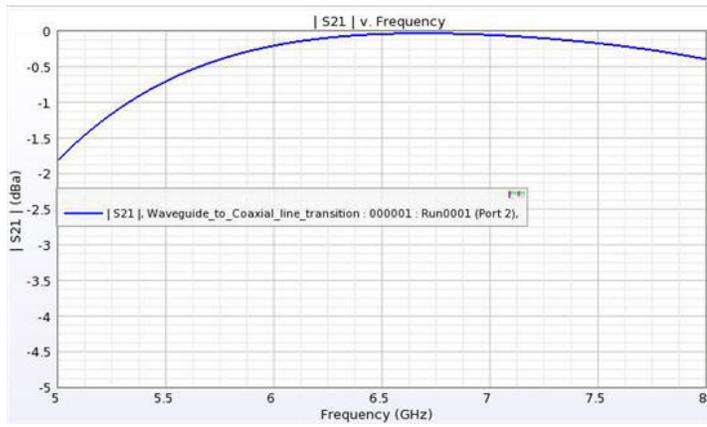
The waveguide to coaxial line transition is analyzed for dominant mode(TE01) propagation in waveguide section and TEM mode coaxial section. The S parameter plot over the frequency band is shown in the following figures:

S11 & S22 Parameter Plot

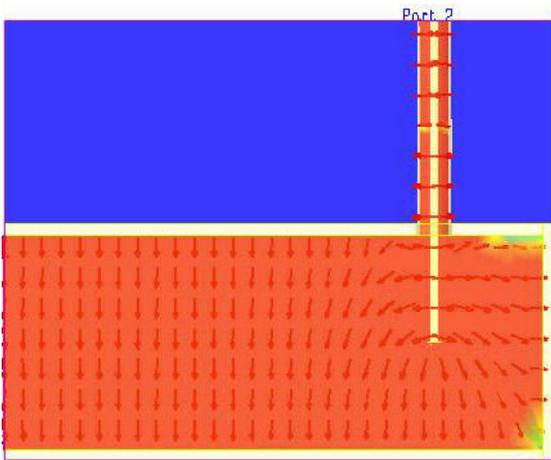


S21 Parameter Plot

Examples



The field plot can be seen from Advanced visualization. Field plot for one cut plane that shows the coupling from waveguide to coaxial section is displayed in the following figure:



Note: Simulate the project **Waveguide_to_Coaxial_line_transition.ep** to see the field plots in Advanced visualization results.

Planar RF Component

This section provides information about the following topics:

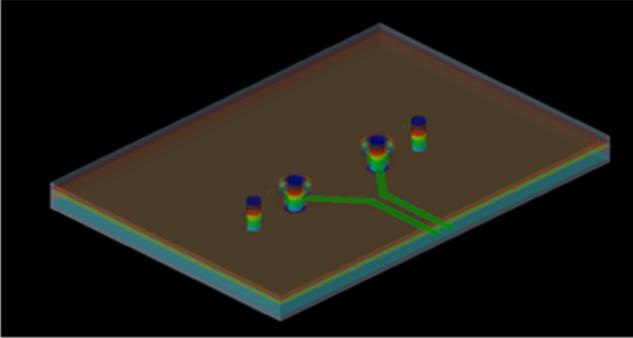
- *Low Pass Filter* (example)
- *LTCC Balun* (example)
- *Microstrip Line* (example)

Differential Vias

Location: In EMPro, choose **Help > Examples > Differential Vias** to open the project.

Objective

This examples illustrates the design of Differential Via using FEM simulator of EMPro. Differential Via model is scalable in multilayer structure. The Differential Via model is shown is following figure:



Setup

Absorbing boundary condition is used in all directions. FEM padding of 25 mil is used in upper X and Y direction and 50 mil is used in Z direction.

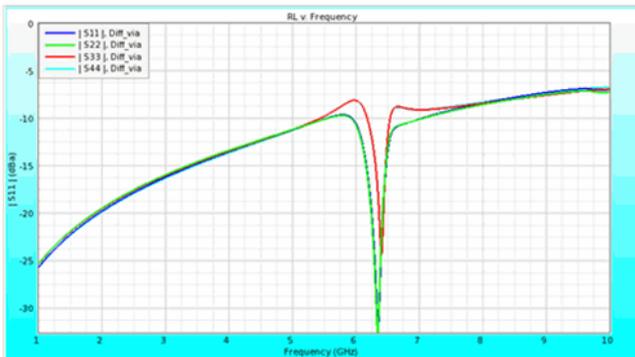
Use the following archive files:

Archive files: **Diff_via.zep**

Analysis

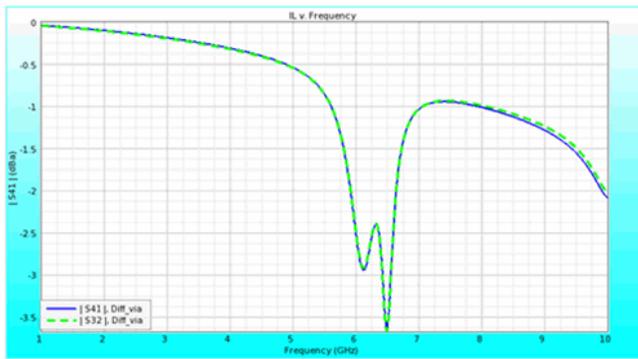
The frequency sweep is carried from 1 GHz to 10 GHz with mesh refinement carried at highest frequency of frequency range.

The return loss plot over the frequency range is displayed in the following figure:



The Insertion Loss plot is displayed in the following figure:

Examples



Note

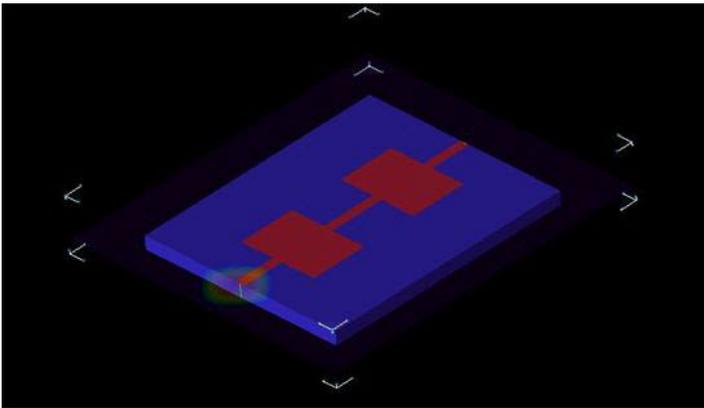
In the Setup FEM Simulation window, access the **Frequency Plan** tab and choose **User defined frequency** in Field Storage. The field data is available at 1,5 and 10 GHz. If field data is required at any other frequency, again simulate the project by using reuse option in FEM simulation.

Low Pass Filter

Location: In EMPro, choose **Help > Examples > Low Pass Filter** to open the project.

Objective

This example illustrates the application of EMPro for the design of planar microstrip passive components such as filter using FEM and FDTD simulations. A stepped impedance low pass filter is displayed in the following figure. In this figure, low pass filter is designed on a substrate of dielectric constant 3 having thickness of 0.64 mm. EMPro provides various types of Near Field sensors through which several field quantities like E, H, B, poynting vector S and surface currents on the surface of the component can be evaluated. In this example, the Surface sensor that is located at port 1 is used to evaluate E, H, and B field quantities along with Surface current Jc and poynting vector S.



Setup

FDTD Setup

A Broadband pulse is used as the source waveform to provide a wide bandwidth frequency response from a single simulation. The 0.3 mm base cell size is used. Adaptive mesh is used along the thickness of the Substrate. The waveform and mesh setup can provide results up to the 100 GHz frequency. The useful frequency range for this device is 0 to 8 GHz.

FEM Setup

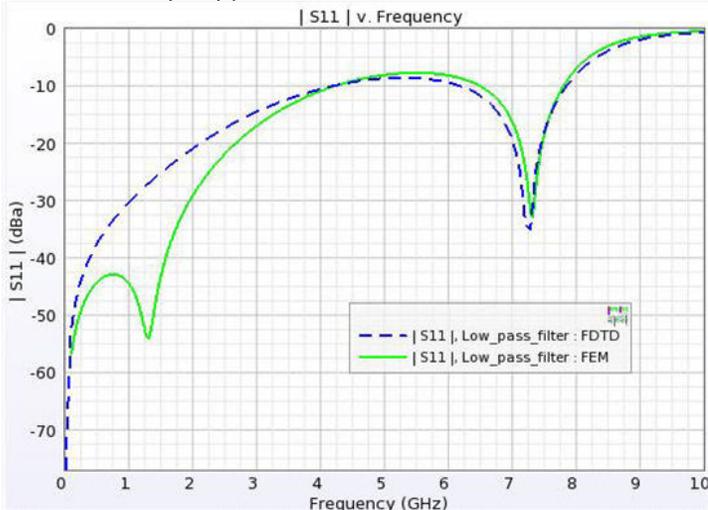
For FEM simulation same geometry, port and boundary setup as of FDTD is used. FEM padding of 30 mm is used in all the directions except Z. For Z on lower padding is 0 mm on lower side and 20 mm on upper side.

Use the following archive file:

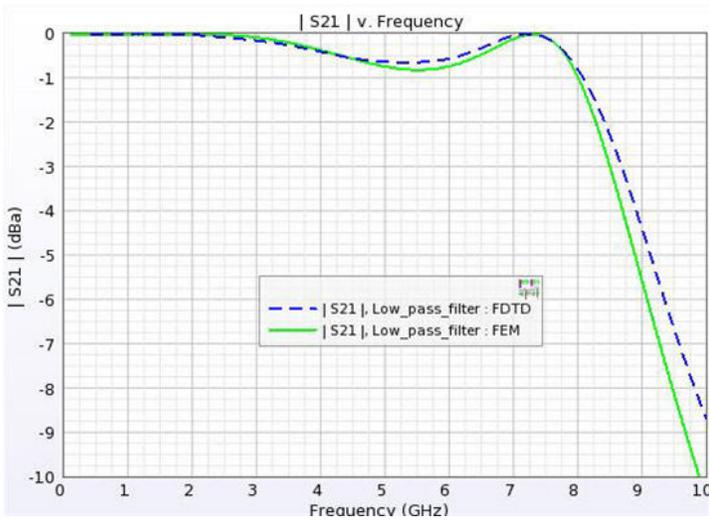
Archive file: **Low_pass_filter.zep**

Analysis

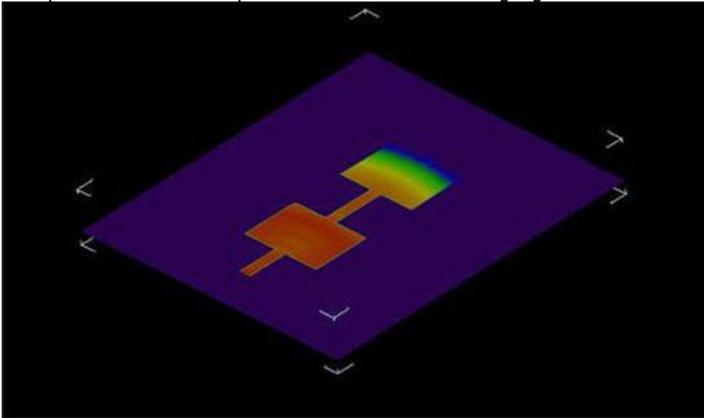
The return loss (S11) performance of the filter is shown in the following figures:



S21 parameter Response



Using the Surface Sensor, different fields E, H, and B poynting vector S and surface current Jc are defined. The progress of these fields with respect to time stepping can be seen in results by choosing Surface Sensor in the output objects. The surface current Jc at one particular time step is shown in the following figure:



In this figure, the field reader tool of EMPro can be used to read the values of quantity which is being plotted over the surface of the low pass filter.

Note
 Simulate the project to view the results. For more information about how to create a low pass filter design, see *Creating a Low Pass Filter Simulation (fdtd)*.

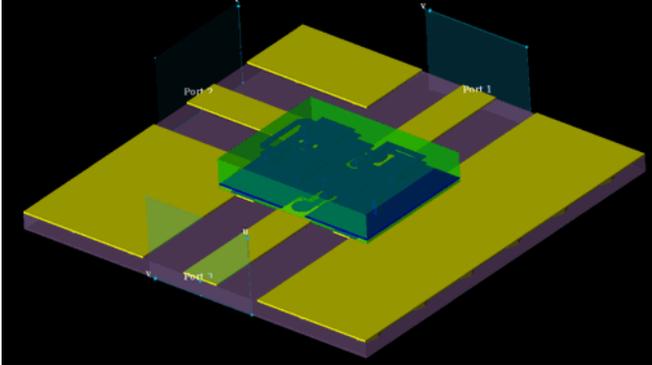
LTCC Balun

Location: In EMPro, choose **Help > Examples > LTCC Balun** to open the project.

Objective

This example illustrates the design of LTCC Balun using FEM simulator of EMPro. LTCC Balun is designed using finite size dielectric brick. The complete 3D EM analysis takes into account the effect of parasitic close to substrate edges.

The LTCC balun is shown is following figure:



Setup

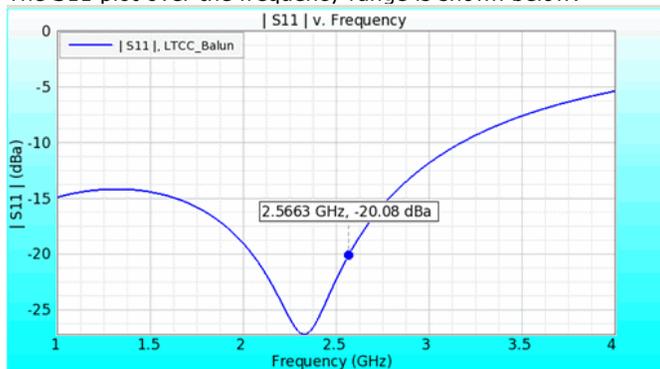
Absorbing boundary condition is used in all directions except lower Z. Lower Z uses PEC boundary condition. FEM padding of 2 mm is used in upper Z direction. Waveguide port is used with 50 Ohm voltage source.

Use the following archive files:
Archive files: **LTCC_Balun.zep**

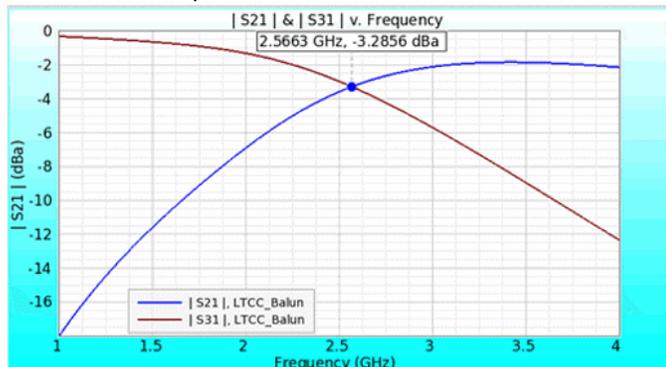
Analysis

The frequency sweep is carried from 1 GHz to 4 GHz with mesh refinement carried at highest frequency of frequency range.

The S11 plot over the frequency range is shown below:

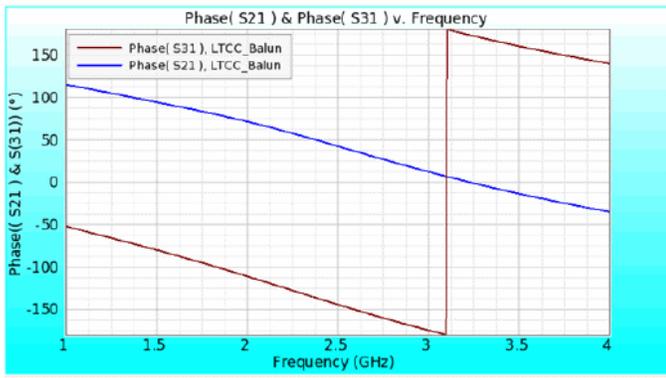


The S21 and S31 plot is shown below:



The following figure shows the phase of S21 and S31 to see phase balance performance:

Examples



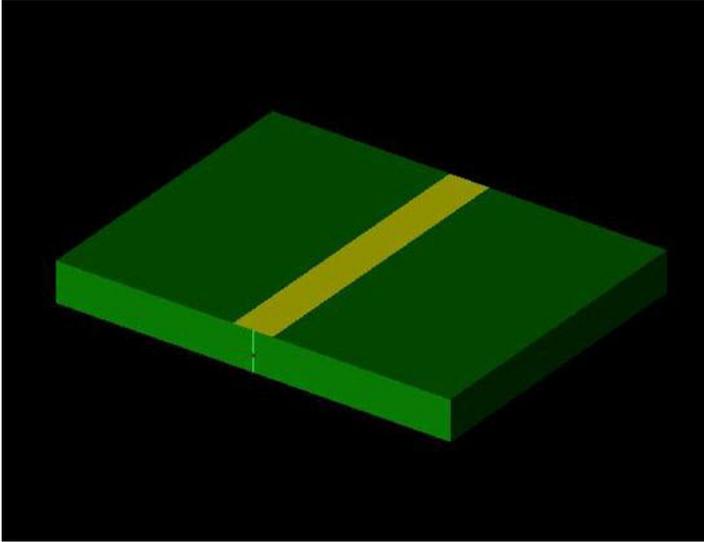
Note
In the **Setup FEM Simulation** window, No field Data option is specified. Therefore, the field data is not available. If field data is required re-simulate the project using reuse option in FEM simulation.

Microstrip Line

Location: In EMPro, choose **Help > Examples > Microstrip Line 50 ohm** to open the project.

Objective

This example describes the design of a Microstrip Line using EMPro using both FEM and FDTD simulations. The line is designed using substrate of dielectric constant 9.9. The thickness of the substrate is 2mm. The width of 50ohm line is 2mm. The Microstrip Line is shown in the following figure:



Setup

FDTD:

The broadband pulse is used to excite the two port microstrip line. The base cell size of 1 mm is used in X and Y directions and 0.5 mm is used in Z directions. In addition, for all the objects of the geometry, automatic fixed points is used in gridding properties. Both 2 port simulation is carried out.

FEM:

For FEM simulation same geometry, port and boundary setup as of FDTD is used. FEM padding of 20 mm is used in all the directions except lower Z. For lower Z 0 mm padding is used

Use the following archive files:

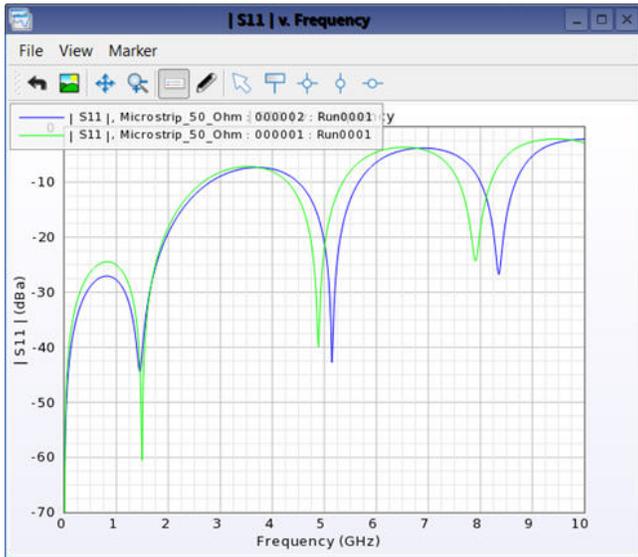
Archive files: **Microstrip_50_Ohm.zep**

Analysis

The return loss S11 and S21 performance of the line is shown in the following figure:

[S11 Results Performance of Microstrip Line](#)

Examples



Eigenmode Solver

This section provides information about the following topics:

- *Eigenmode Solver on a DC-SIR Cylinder* (example)

Eigenmode Solver on a DC-SIR Cylinder

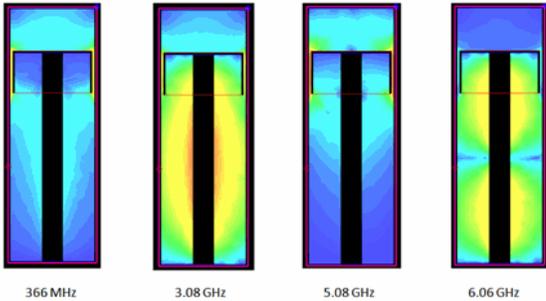
Location: In EMPro, choose **Help** > **Examples** > **Eigenmode Solver on a DC-SIR Cylinder** to open the project.

Objective

In this example, a double coaxial stepped impedance resonator (DC-SIR) is simulated. Currently, EMPro does not support cylindrical boundaries. For cylindrical or other non-rectangle cavities, it is important to put a rectangular metal background to avoid external artificial cavities between the metal walls and FEM boundaries.

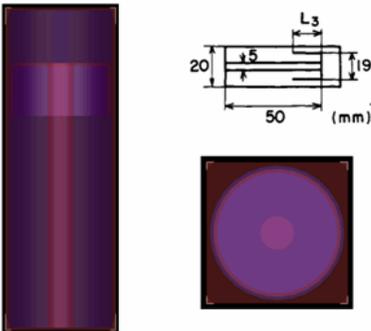
Setup

The dimension of the resonator is shown in the following figure, where L3 is set to be 10 mm in this simulation:



Analysis

The Eigen frequencies and Q values are shown below with copper metals. The total elapsed time is 46 seconds. Note that the eigenmode solver is multi-threaded so that the *Elapsed time* is shorter than the *CPU time* in each solving pass. The eigen fields at corresponding frequencies are shown in the following figure:



The following figure displays the eigen fields for DC-SIR:

```

INITIAL MESH
-----
nbPoints      : 912
nbTetrahedra : 3129

REFINING
-----

```

MESHING				SOLVING					
level	freq(GHz)	nbTetr	Elapsed time	CPU time	nbUnknowns	mem(GB)	Elapsed time	CPU time	Delta(S)
1	3128	00:00:08.1	00:00:07.9	23854	0.226	00:00:09.1	00:00:22.8	/	
2	3796	00:00:01.9	00:00:01.0	28396	0.270	00:00:11.2	00:00:27.7	0.002[=>0.010]	
3	4510	00:00:01.3	00:00:01.2	33384	0.312	00:00:13.7	00:00:33.6	0.002[=>0.010]	

```

Eigenfrequencies | Q values
1. 3.664557e+008 | 1.166235e+003
2. 3.080868e+009 | 3.046764e+003
3. 5.077350e+009 | 5.705200e+002
4. 6.056062e+009 | 4.404977e+003

Total Elapsed Time = 0:00:46

```

General Examples

This section provides information about the following topics:

- *Agilent Phone* (example)
- *Agilent Phone with Phantom* (example)
- *QFN Package* (example)
- *RCS of Aircraft* (example)
- *Twisted Wire Pair* (fddt)

Agilent Phone

Location: In EMPro, choose **Help > Examples > Agilent Phone** to open the project.

Objective

This example illustrates the capability of EMPro in designing Mobile phone antenna system using FDTD Simulator. Both Bluetooth and GSM antennas are analyzed within mobile phone casing with many associated materials of different dielectric constant around it.



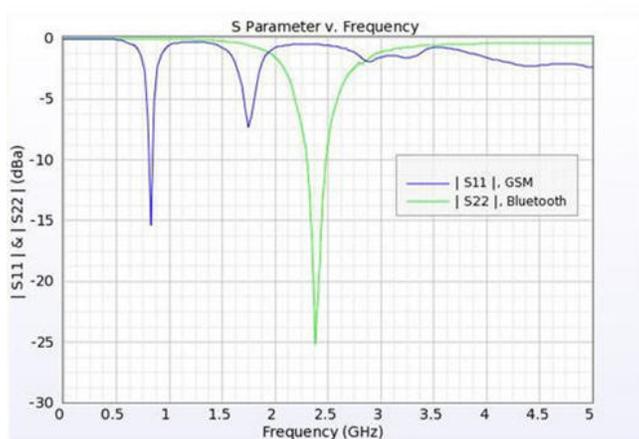
Setup

A CAD file having the mobile phone structure with both antennas is imported in EMPro. The project is set up in EMPro by assigning materials to different components, defining ports for both GSM and Bluetooth antenna and defining mesh. Archive files: **AGILENT_PHONE.zep**

Analysis

The GSM antenna has -15dB and -7dB return loss in GSM bands. The return loss performance of both GSM and Bluetooth antennas are shown in the following figure:

Return Loss Performance

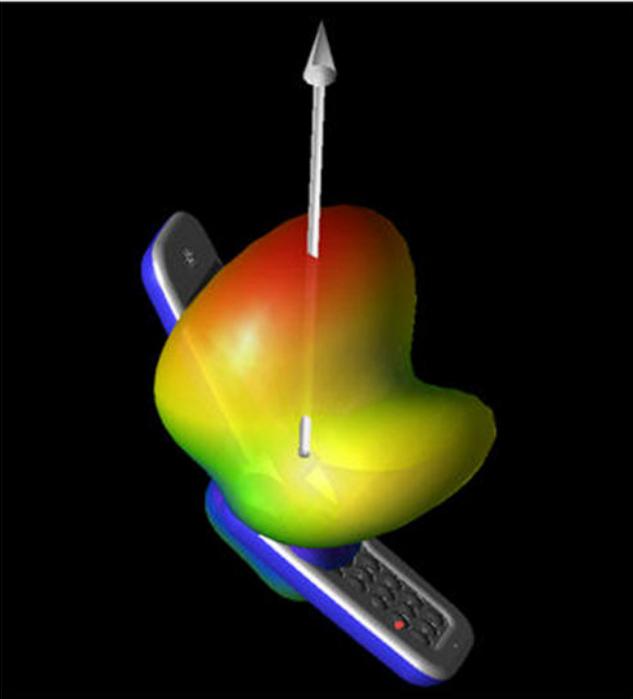


The GSM antenna is located at the bottom of the phone. The radiation pattern of the GSM

Examples

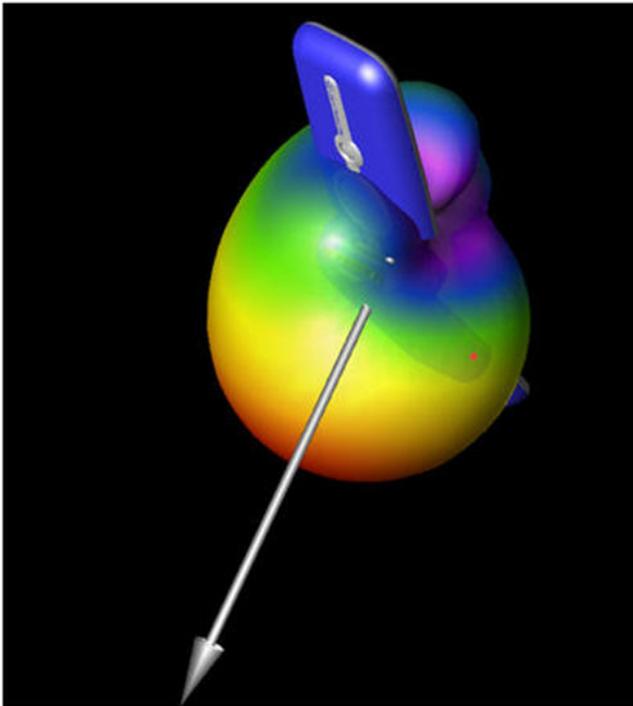
antenna in presence of complete mobile phone structure is shown in the following figure:

Radiation Pattern for a GSM Antenna



The Bluetooth antenna gives -25dB return loss. Similarly, the radiation pattern of Bluetooth antenna is shown in the following figure:

Radiation Pattern for a Bluetooth Antenna



Agilent Phone with Phantom

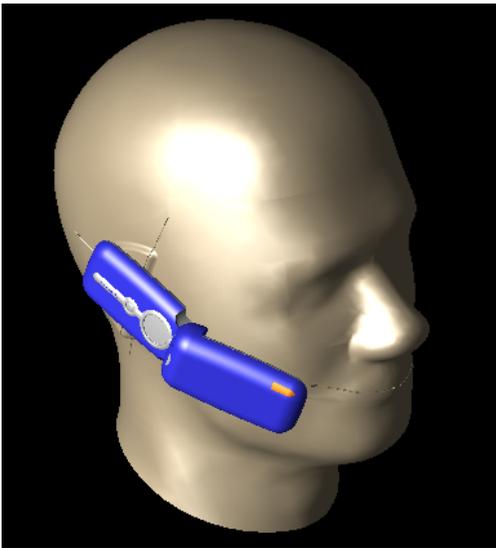
Location: In EMPro, choose **Help > Examples > Agilent Phone with Phantom** to open the projects.

Objective

This example illustrates the SAR calculation capability of EMPro using FDTD simulator. The mobile phone structure with radiating GSM antenna is analyzed in the presence of a human head structure to calculate the SAR maximum and average data.

In this example, the mobile phone CAD file is imported in the sat format. The project is configured by assigning different materials to different components. In this example, two antennas, one operating at the GSM band and another operating at Bluetooth are analyzed. The mobile phone structure is also analyzed in the presence of a human head structure to calculate the SAR maximum and average data. The Agilent phone is shown in the following figure where both GSM and Bluetooth antennas are placed.

Agilent Phone



Setup

A CAD file having the mobile phone structure with both antennas and a phantom model is imported in EMPro. The project is set up in EMPro by assigning materials to different components, defining ports for both GSM and Bluetooth antenna and defining mesh. To analyze the performance of antennas in the presence of human head structure, a CAD file human head structure is imported and material for inner and outer shell is assigned. Use the following archive files:

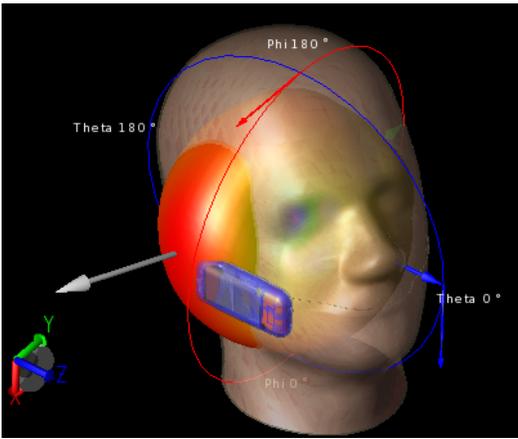
Archive files: **AGILENT_PHONE_HEAD.zep**

Analysis

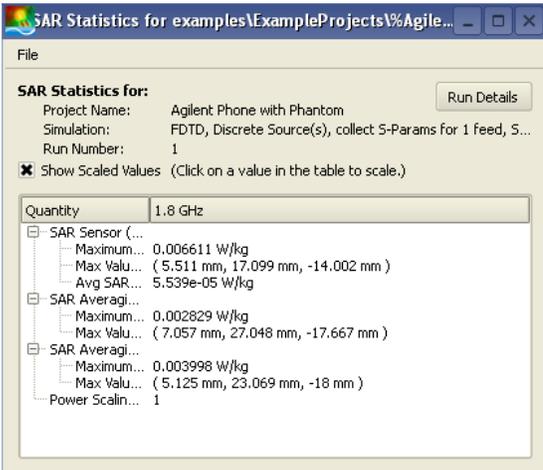
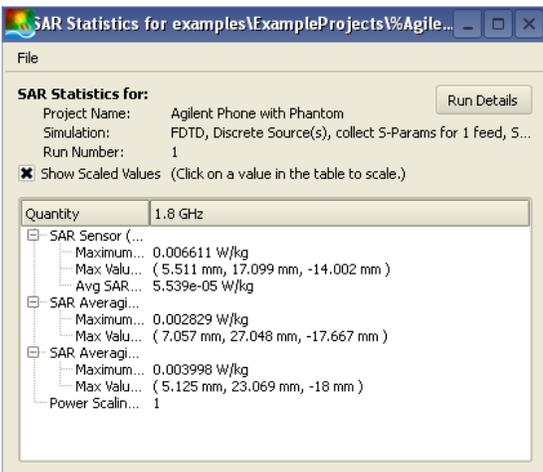
The analysis of a GSM antenna for S parameter and radiation pattern along with SAR calculation is done in separate project *AGILENT_PHONE_HEAD.ep*. The pattern of the antenna gets distorted in the presence of a human head structure. The following figure shows the radiation pattern of a GSM antenna in the presence of a human head structure:

Radiation Pattern in the Presence of a Human Head Structure

Examples



In the project, the result for SAR 10g, 1g, and RAW data is also shown. These results show the SAR maximum value and its location for 1.8 GHz. In addition, the SAR average 1g and 10g at different location of the geometry can also be seen in results. The RAW SAR data collection is enabled for full grid, as Required by SAR averaging sensor.

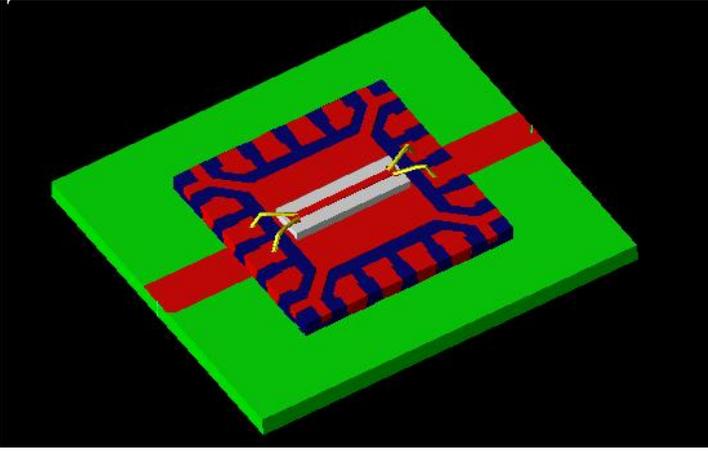


QFN Package

Location: In EMPro, choose **Help > Examples > QFN Package**.

Overview

This example describes the FEM simulation of a QFN Package. The QFN package model is imported in EMPro from CAD model.



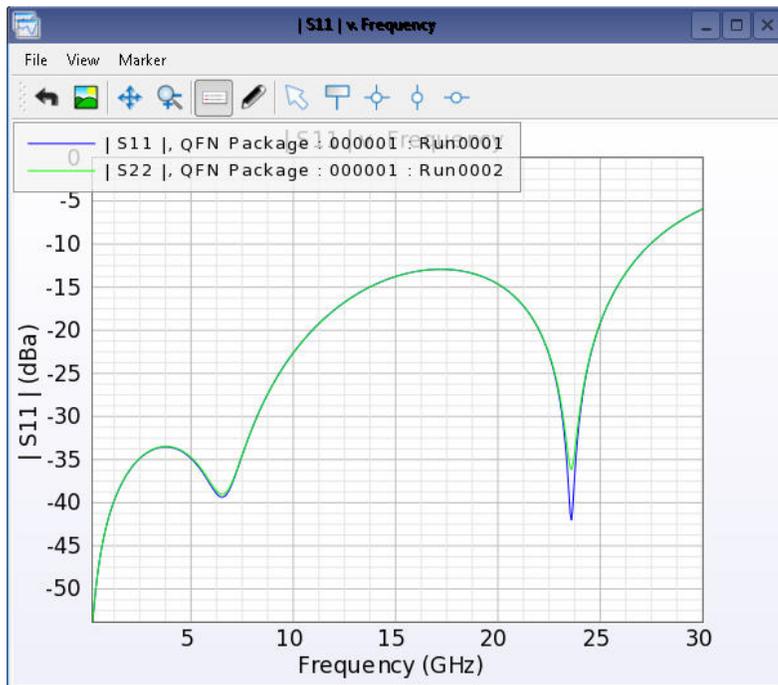
Setup

The FEM simulation is carried out from 0-30 GHz. The boundary condition is absorbing on all the sides except lower Z. In lower Z side the PEC boundary condition is applied. This is a two port structure. Internal ports are used for the simulation
Archive files: **QFN_Package.zep**

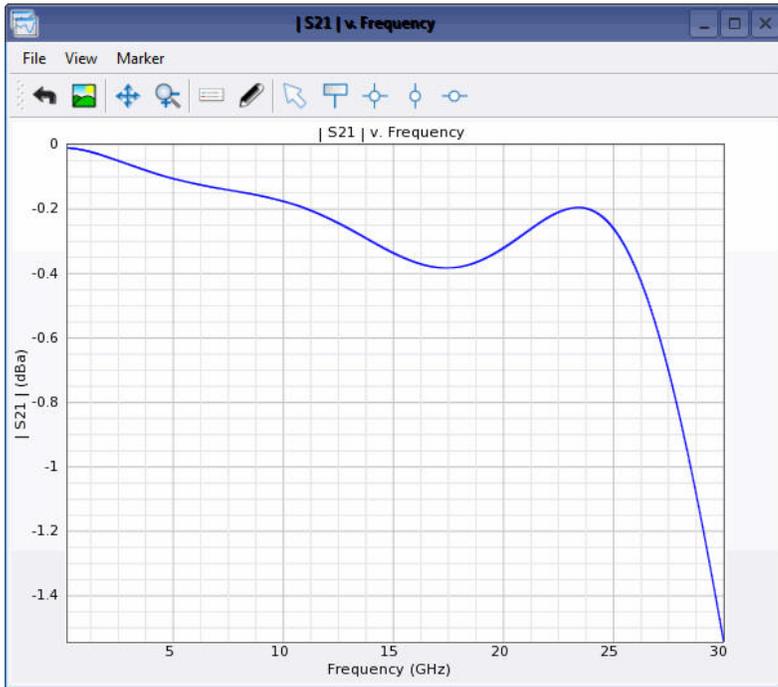
Analysis

The QFN package is analyzed at mesh frequency of 30 GHz, which is the highest frequency of the band. The S parameter plot over the frequency band is shown in the following figure:

S11 & S22 Parameter Plot

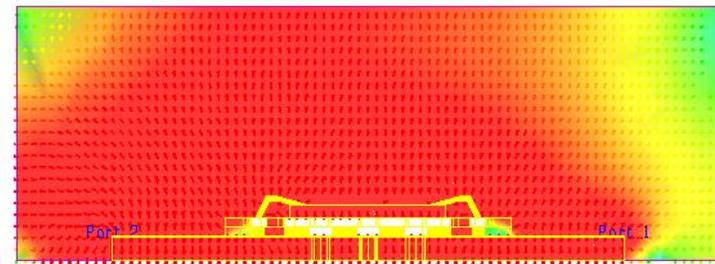


S21 Parameter Plot



Field Plot

The field plot can be seen from Advanced visualization. Field plot for one cut plane in the structure is shown below:



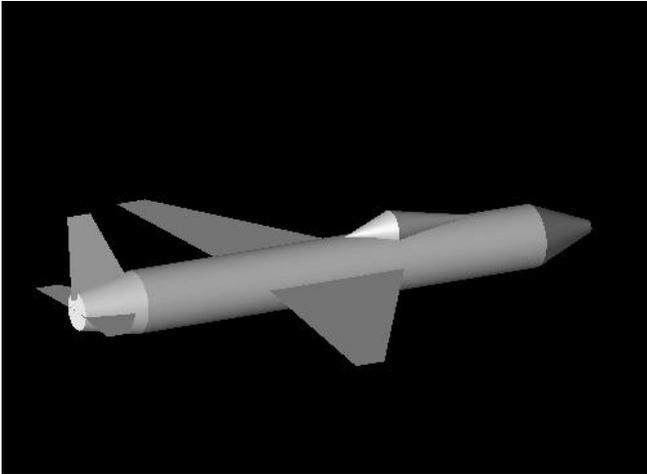
Note: Simulate the project **Waveguide_power_divider.ep** to see the field plots in Advanced visualization results.

RCS of Aircraft

Location: In EMPro, choose **Help > Examples > Example Projects > RCS of Aircraft** to open the project.

Objective

This example describes the application of EMPro for evaluating the Radar Cross Section (RCS) of an Aircraft. EMPro provides the facility to excite different surfaces and structures by an external source. Both Plane wave and Gaussian beam type of external source are available in EMPro. The external source also provides the facility to excite in either of Ephi or Etheta polarization in any incident phi or theta directions. The aircraft that is used in this example is 9m in length and is imported in EMPro through robust CAD import facility. EMPro consists of the advanced CAD import facility that supports all standard CAD files formats such as: sat, sab, iges, dxf, stp, ProE, unigraphics, and inventor. The following figure displays the aircraft model:



Setup

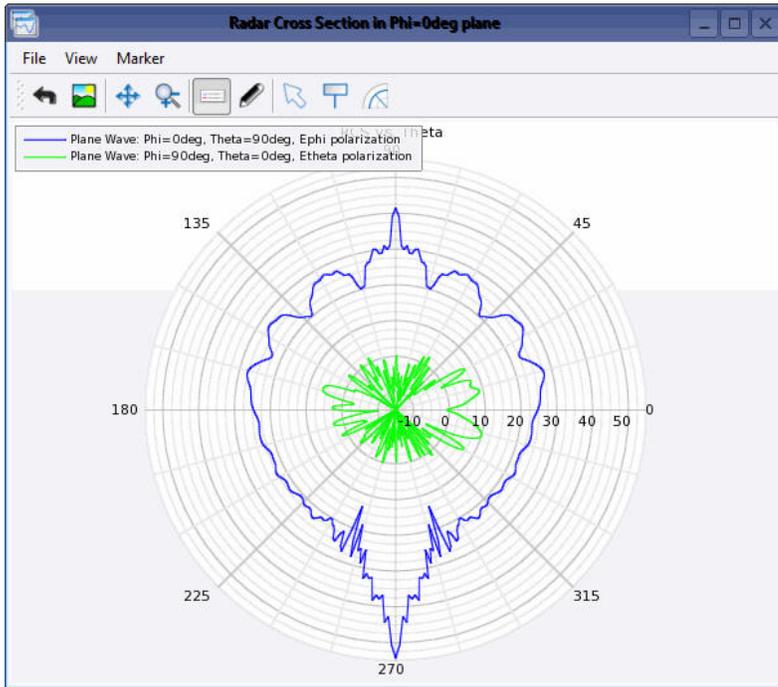
The RCS is evaluated at 1GHZ. The geometry is 30 lambda in length at this frequency and EMPro is able to calculate RCS of the aircraft. The broadband pulse is used in waveform. The base cell size of 25mm is used with 20 padding in all the directions. The plane wave source is used for external excitation. Two simulations were carried out for different incident directions and polarizations. In the first simulation, E phi Polarization is used from Phi at 0 degrees and Theta at 90 degrees incident direction. In the second simulation, the ETheta polarization is used from Phi at 90 degrees and Theta at 0 degrees incident direction. In both of these simulations, the total/Scattered field formulation is used and without computing the dissipated power. These settings makes easy convergence and fast simulation. Use the following archive files:

Archive files: **RCS_Aircraft.zep**

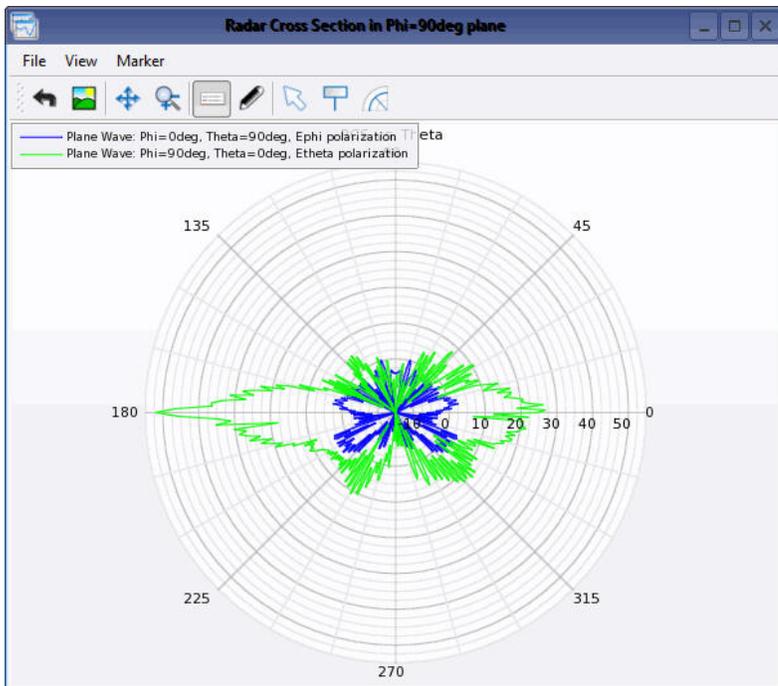
Analysis

The RCS plot in Phi at 0 degrees plane cut for both simulations is shown in the following figure:

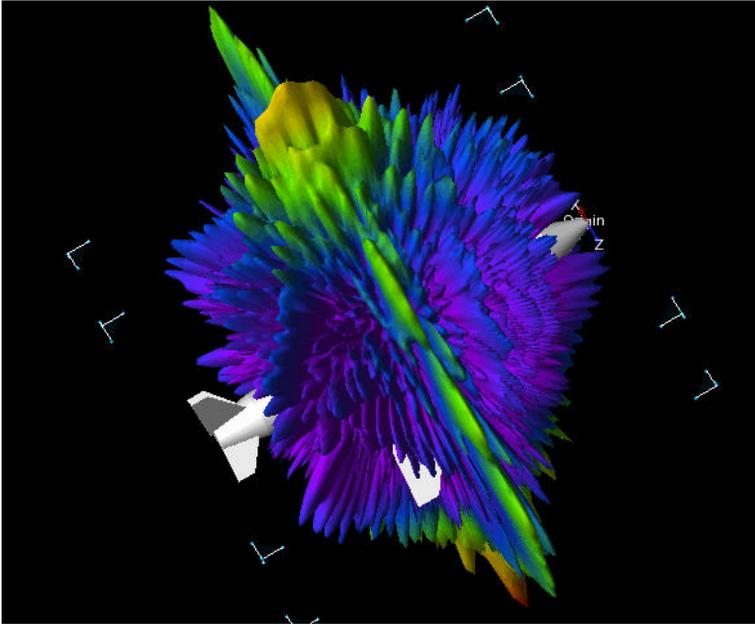
Examples



The RCS plot in Phi at 90 degrees plane cut for both the simulation is shown in the following figure:



The 3D RCS plot for simulation 1 is shown in the following figure. The RCS value is 54.32dBsm.



The 3D RCS plot for simulation 2 is shown in the following figure. The RCS value is 51.89dBsm.

